RSS125N03

Transistors

Switching (30V, 12.5A)

RSS125N03

Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small and Surface Mount Package (SOP8).

Application

Power switching, DC / DC converter.

Structure

Silicon N-channel MOS FET

Packaging specifications

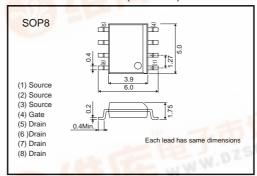
- LT	Package	Taping
Туре	Code	TB
	Basic ordering unit (pieces)	2500
RSS125N03	0	

● Absolute maximum ratings (Ta=25°C)

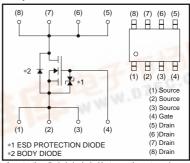
Parameter		Symbol	Limits	Unit		
Drain-source voltage		V _{DSS}	30	V		
Gate-source voltage		V _{GSS}	20	V		
Drain current	Continuous	lo	±12.5	A		
	Pulsed	I _{DP}	±50	A *1		
Source current	Continuous	Is	1.6	A		
(Body diode)	Pulsed	I _{SP}	6.4	A *1		
Total power dissipation		PD	2	W *2		
Channel temperature		Tch	150	°C		
Storage temperature		Tstg	-55 to 150	°C		

^{*1} Pw≤10µs, Duty cycle≤1% *2 Mounted on a ceramic board.

●External dimensions (Unit: mm)



●Equivalent circuit



A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

●Thermal resistance (Ta=25°C)

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth (ch-a)	62.5	°C / W *

^{*} Mounted on a ceramic board





●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	-	_	±10	μΑ	V _{GS} =±20V, V _{DS} =0V
Drain-source breakdown voltage	V _(BR) DSS	30	_	_	V	I _D =1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	_	_	1	μΑ	Vps=30V, Vgs=0V
Gate threshold voltage	VGS (th)	1.0	_	2.5	٧	Vps=10V, Ip=1mA
Static drain-source on-state resistance		_	6.5	8.9	mΩ	I _D =12.5A, V _{GS} =10V
	R _{DS (on)} *	-	8.6	11.8		I _D =12.5A, V _{GS} =4.5V
		-	9.3	12.8		I _D =12.5A, V _{GS} =4V
Forward transfer admittance	Y _{fs} *	10	_	_	S	I _D =12.5A, V _{DS} =10V
Input capacitance	Ciss	_	1670	_	рF	V _{DS} =10V
Output capacitance	Coss	_	470	_	рF	V _{GS} =0V
Reverse transfer capacitance	Crss	_	270	_	pF	f=1MHz
Turn-on delay time	t d (on) *	_	10	_	ns	I _D =6.25A, V _{DD} ≒15V
Rise time	t r *	_	17	_	ns	Vgs=10V
Turn-off delay time	t _{d (off)} *	_	69	_	ns	RL=2.40Ω
Fall time	t _f *	-	30	_	ns	R _{GS} =10Ω
Total gate charge	Q _g *	_	20	28	nC	V _{DD} =15V
Gate-source charge	Q _{gs} *	-	4.2	_	nC	V _{GS} =5V
Gate-drain charge	Q _{gd} *		8.0		nC	I _D =12.5A

^{*}Pulsed

●Body diode characteristics (Source-Drain Characteristics) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	V _{SD} *	-	_	1.2	V	I _S =6.4A, V _{GS} =0V

^{*}Pulsed

•Electrical characteristic curves

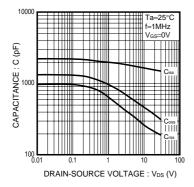


Fig.1 Typical Capacitance vs. Drain-Source Voltage

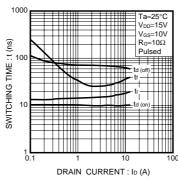


Fig.2 Switching Characteristics

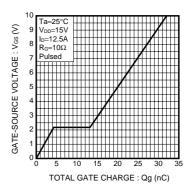


Fig.3 Dynamic Input Characteristics

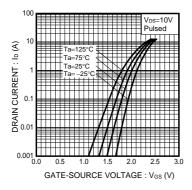


Fig.4 Typical Transfer Characteristics

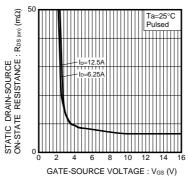


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

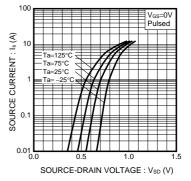


Fig.6 Source Current vs. Source-Drain Voltage

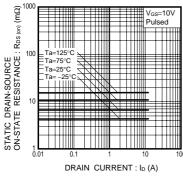


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

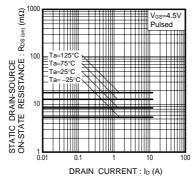


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

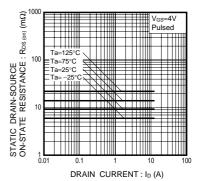


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

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